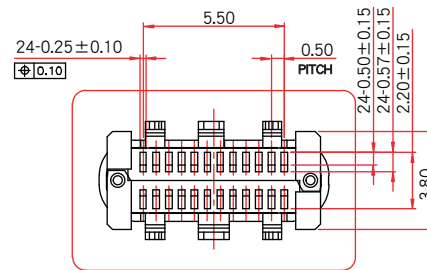


NOTES:

- MATERIAL:
MOLDING: LCP UL94 V-0
CONTACT: COPPER ALLOY.
GOLD PLATING ALL OVER 50u" Min NICKEL
AND 100u" Min Tin ALL OVER 50u" Min NICKEL
ON SOLDER AREA
SHELL: SUS304-H, T=0.30±0.03mm
50u" NICKEL PLATING OVER ALL.
SHILD: SUS304-H, T=0.12±0.03mm
- MECHANICAL:
INSERTION: 5~20N.
EXTRACTION: 8~20N.
DURABILITY: 10000 CYCLES
- ELECTRICAL:
CURRENT: 5A MIN FOR VBUS;
0.25A MIN FOR OTHER.
VOLTAGE: 5VAC MAX
WITHSTANDING VOLTAGE: 100V AC.
CONTACT RESISTANCE: 40mΩ MAX.
INSULATION RESISTANCE: 100MΩ MIN.
- ENVIRONMENTAL
TEMPERATURE RANGE -55°C ~ +85°C



UNITS mm	SCALE 1:1	REV. B3	SHEET 1 OF 1	TITLE	
		DATE 2014.08.25		USB3.1 C TYPE 立式SMT (L=10.50mm)	
		DR. Andy.Pi		SEE TABLE	
GENERAL TOLERANCE 0. ±0.30 0.0 ±0.20 0.00 ±0.15 0.' ±4' 0.0' ±2'		CHK. Andy.Pi		FINISH SEE TABLE	
		APPD. zhufagui		DWG.NO.	
		A		PART NO. SEE TABLE	
				SIZE A4	